Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S61	2547	257/784.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/30 14:23
S62	822	S61 and (polyimide polymer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 14:46
S63	704	S62 and @ad<"20040924"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 11:29
S64	4	("4523371"   "5525839"   "5572070"   "5646439").PN. OR ("7224044"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/30 17:44
S65	4188650	(polymer polyimide resin mold epoxy)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/30 17:54
S66	5978221	(ring circular circle round donut disk centerless center-less)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:05
S67	209795	S65 with S66	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:19

S68	2367297	(IC (integrate\$1 near circuit) (semiconductor near (chip device element dice)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT;	OR	ON	2007/10/30 18:07
S69	2667881	(wir\$3)	IBM_TDB  US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT;	OR	ON	2007/10/30 18:07
S70	575659	S68 and S69	IBM_TDB US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:07
S71	8738	S67 and S70	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:07
S72	5463	S71 and @ad<"20040924"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:08
S73	4359	S67 with S69	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:19
S74	2264	257/786.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:22

S75	10	S73 and S74	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:19
S76	1417	257/718.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:22
S77	1	S73 and S76	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:23
S78	104	257/580.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:23
S79	0	S73 and S78	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:23
S80	2795	257/773.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:23
S81	3	S80 and S73	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:24

S82	892	257/775.ccls.	US-PGPUB;	OR	ON	2007/10/30 18:24
			USPAT; USOCR; FPRS;			
,			EPO; JPO; DERWENT; IBM_TDB			
S83	0	S73 and S82	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:25
S84	2108	257/690.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:25
S85	9	S73 and S84	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:28
S86	2085	257/692.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:28
S87	6	S73 and S86	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:29
S88	1660	257/780.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/30 18:29

	i i					
S89	14	S73 and S88	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:31
S90	. 2246	257/738.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:32
S91	4188650	(polymer polyimide resin mold epoxy)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:44
S92	5978221	(ring circular circle round donut disk centerless center-less)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:38
S93	209795	S91 with S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:32
S94	2667881	(wir\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:32
S95	4359	S93 with S94	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:32

S96	16	S95 and S90	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:37
S97	4359	S95 and S93	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:37
S98	4359	S97 and S94	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 11:37
S99	6377604	(ring circular circle round donut disk centerless center-less annular annualist annularly annularity)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 12:07
S10 0	4188650	(polymer polyimide resin mold epoxy) .	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:17
S10 1	156779	S100 near8 S99	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:48
S10 2	697	438/18.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:48

S10 3	9	S102 and S101	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:49
S10 4	3035	438/612.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:49
S10 5	46	S101 and S104	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:52
S10 6	. 669	438/756.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:52
S10 7	1	S101 and S106	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:54
S10 8	445	257/e23.025.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:55
S10 9	15	S101 and S108	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 11:55

S11 0	20	("20030027918"   "20030090001"   "4523371"   "4788583"   "4974057"   "5097317"   "5206794"   "5310702"   "5331205"   "5434105"   "5736792"   "5818105"   "5824568"   "6177726"   "6215182"   "6297078"   "6340846"   "6344401"   "6368899"   "6395807"). PN. OR ("6955949").URPN.	US-PGPUB; USPAT; USOCR	OR ·	OFF	2007/10/31 11:56
S11 1	12	("4707725"   "4819041"   "4888634"   "5359227"   "5389738"   "5569956"). PN. OR ("5736792").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/31 12:07
S11 2	4515	257/666.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:07
S11 3	15134182	(strip piece line cover\$3 side segment pattern)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/31 18:17
S11 4	4188650	(polymer polyimide resin mold epoxy)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:17
S11 5	586221	S114 near8 S113	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:18
S11 6	250	257/e23.033.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:27

S11 7	69	S115 and S116	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:27
S11 8	1393	257/e23.068.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:27
S11 9	361	S115 and S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/31 12:27
S12 0	5	("5186377"   "5220200"   "5825635"   "5933343"   "6218730").PN. OR ("6646356").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/10/31 12:41
S12 1	15219502	(strip piece line cover\$3 side segment pattern corner)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 11:21
S12 2	3	(nonvolatile near memory) with package with (window)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 11:28
S12 3	161	(nonvolatile near memory) with (window)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 11:29

S12 4	108	S123 and @ad<"20040924"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 12:36
S12 5	4190035	(polymer polyimide resin mold epoxy)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/11/01 12:35
S12 6	17517	S125 with (window)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/11/01 11:37
S12 7	643	S126 with (wir\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/11/01 12:35
S12 8	533	S127 and @ad<"20040924"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/01 12:36

11/1/2007 9:57:01 PM C:\Documents and Settings\tnguyen40\My Documents\EAST\Workspaces\10711140.wsp

Page 10